

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Jun-Ho Jang	11/25/2009
Woonjae Chung	11/25/2009
Hungjun An	12/02/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Samsung Electronics Co., Ltd.
<b>Street Address:</b>	416 Maetan-dong Yeongtong-gu, Suwon-si
<b>City:</b>	Gyeonggi-do
<b>State/Country:</b>	REPUBLIC OF KOREA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12631267
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(919)854-1401
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Email:</b>	awooten@myersbigel.com
<b>Correspondent Name:</b>	Audra Wooten
<b>Address Line 1:</b>	4140 Parklake Avenue
<b>Address Line 2:</b>	Suite 600
<b>Address Line 4:</b>	Raleigh, NORTH CAROLINA 27612
<b>ATTORNEY DOCKET NUMBER:</b>	5649-2686
<b>NAME OF SUBMITTER:</b>	Audra Wooten

Total Attachments: 4  
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**501033404**

**PATENT  
 REEL: 023612 FRAME: 0531**

**CH \$40.00 12631267**



**ASSIGNMENT**

THIS ASSIGNMENT, made by us, **Jun-Ho Jang**, citizen of the Republic of Korea, residing at 205-1005, Ssangyong Apt., Garak 2-dong, Songpa-gu, Seoul, Republic of Korea, **Woonjae Chung**, citizen of the Republic of Korea, residing at 991-1601, Baekdu Hanyang Apt., Gungnae-dong, Gunpo-si, Gyeonggi-do, Republic of Korea; and **Hungjun An**, citizen of the Republic of Korea, residing at 404-802, Neuchimi Maeul 4-danji, Byeongjeom-dong, Hwaseong-si, Gyeonggi-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in **METHOD OF FABRICATING SYSTEMS INCLUDING HEAT-SENSITIVE MEMORY DEVICES** for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. 12/631,267, filed 12/4/09) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, **Samsung Electronics Co., Ltd.**, a Korean corporation having a principal place of business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as

**ASSIGNMENT – CONTINUED**

fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 2<sup>nd</sup> day of November, 2009.

Jun Ho Jang (SEAL)  
**Jun-Ho Jang**

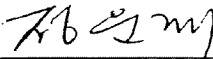
Witnessed by:

\_\_\_\_\_

Date: \_\_\_\_\_

**ASSIGNMENT – CONTINUED**

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 25 day  
of 11, 2009.

  
\_\_\_\_\_  
**Woonjae Chung** (SEAL)

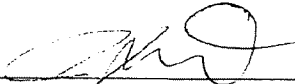
Witnessed by:

\_\_\_\_\_

Date: \_\_\_\_\_

**ASSIGNMENT – CONTINUED**

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 2<sup>th</sup> day  
of 12, 2009.

  
\_\_\_\_\_  
**Hungjun An** (SEAL)

Witnessed by:

\_\_\_\_\_

Date: \_\_\_\_\_